SLRS021A - DECEMBER 1976 - REVISED MAY 1993

PERIPHERAL DRIVERS FOR HIGH-CURRENT SWITCHING AT VERY HIGH SPEEDS

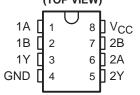
- Characterized for Use to 300 mA
- High-Voltage Outputs
- No Output Latch-Up at 20 V (After Conducting 300 mA)
- High-Speed Switching
- Circuit Flexibility for Varied Applications
- TTL-Compatible Diode-Clamped Inputs
- Standard Supply Voltages
- Plastic DIP (P) With Copper Lead Frame Provides Cooler Operation and Improved Reliability
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

SUMMARY OF DEVICES

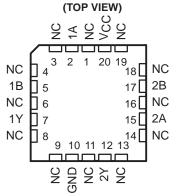
DEVICE	LOGIC OF COMPLETE CIRCUIT	PACKAGES
SN55451B	AND†	FK, JG
SN55452B	NAND	JG
SN55453B	OR	FK, JG
SN55454B	NOR	JG
SN75451B	AND	D, P
SN75452B	NAND	D, P
SN75453B	OR	D, P
SN75454B	NOR	D, P

[†] With output transistor base connected externally to output of gate

SN55451B, SN55452B, SN55453B, SN55454B . . . JG PACKAGE SN75451B, SN75452B, SN75453B, SN75454B . . . D OR P PACKAGE (TOP VIEW)



SN55451B, SN55452B SN55453B, SN55454B . . . FK PACKAGE



NC - No internal connection

description

The SN55451B through SN55454B and SN75451B through SN75454B are dual peripheral drivers designed for use in systems that employ TTL logic. This family is functionally interchangeable with and replaces the SN75450 family and the SN75450A family devices manufactured previously. The speed of the devices is equal to that of the SN75450 family, and the parts are designed to ensure freedom from latch-up. Diode-clamped inputs simplify circuit design. Typical applications include high-speed logic buffers, power drivers, relay drivers, lamp drivers, MOS drivers, line drivers, and memory drivers.

The SN55451B/SN75451B, SN55452B/SN75452B, SN55453B/SN75453B, and SN55454B/SN75454B are dual peripheral AND, NAND, OR, and NOR drivers, respectively (assuming positive logic), with the output of the logic gates internally connected to the bases of the npn output transistors.

The SN55' drivers are characterized for operation over the full military range of -55°C to 125°C. The SN75' drivers are characterized for operation from 0°C to 70°C.

SN55451B, SN55452B, SN55453B, SN55454B SN75451B, SN75452B, SN75453B, SN75454B DUAL PERIPHERAL DRIVERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

		SN55'	SN75'	UNIT	
Supply voltage, V _{CC} (see Note 1)		7	7	V	
Input voltage, V _I	5.5	5.5	V		
Inter-emitter voltage (see Note 2)	5.5	5.5	V		
Off-state output voltage, VO		30	30	V	
Continuous collector or output current, IOK (see Note 3)	400	400	mA		
Peak collector or output current, I _I ($t_W \le 10$ ms, duty cycle $\le 50\%$, se	500	500	mA		
Continuous total power dissipation		See Dissipation Rating Table			
Operating free-air temperature range, TA		-55 to 125	0 to 70	°C	
Storage temperature range, T _{Stg}		-65 to 150	-65 to 150	°C	
Case temperature for 60 seconds	FK package	260		°C	
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	JG package	300		°C	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	D or P package		260	°C	

- NOTES: 1. Voltage values are with respect to network GND, unless otherwise specified.
 - 2. This is the voltage between two emitters of a multiple-emitter transistor.
 - 3. This value applies when the base-emitter resistance (R_{BE}) is equal to or less than 500 Ω .
 - 4. Both halves of these dual circuits may conduct rated current simultaneously; however, power dissipation averaged over a short time interval must fall within the continuous dissipation rating.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	-		T _A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	_
FK	1375 mW	11.0 mW/°C	880 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	210 mW
Р	1000 mW	8.0 mW/°C	640 mW	_

recommended operating conditions

	SN55'			SN75'			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level input voltage, V _{IH}	2			2			V
Low-level input voltage, V _{IL}			0.8			0.8	V
Operating free-air temperature, T _A	-55		125	0		70	°C



logic symbol†

& ▷ 1B 6 2A 7 2B

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC publication 617-12.

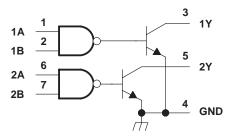
Pin numbers shown are for the D, JG, and P packages.

FUNCTION TABLE (each driver)

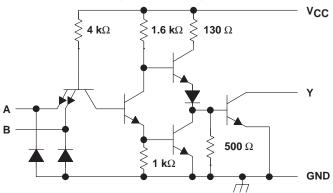
Α	В	Y
L	Г	L (on state)
L	Н	L (on state)
Н	L	L (on state)
Н	Н	H (off state)

positive logic: $Y = AB \text{ or } \overline{A} + \overline{B}$

logic diagram (positive logic)



schematic (each driver)



Resistor values shown are nominal.

electrical characteristics over recommended operating free-air temperature range

	PARAMETER	TEST SON	DITIONOT	S	N55451E	3	SN75451B			UNIT
	PARAMETER	TEST CONDITIONS‡		MIN	TYP§	MAX	MIN	TYP§	MAX	UNII
VIK	Input clamp voltage	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$		-1.2	-1.5		-1.2	-1.5	V
\/	Low lovel output voltoge	V _{CC} = MIN, I _{OL} = 100 mA	$V_{IL} = 0.8 V,$		0.25	0.5		0.25	0.4	
VOL	Low-level output voltage	V _{CC} = MIN, I _{OL} = 300 mA	V _{IL} = 0.8 V,		0.5	0.8		0.5	0.7	V
ЮН	High-level output current	V _{CC} = MIN, V _{OH} = 30 V	V _{IH} = MIN,			300			100	μΑ
Ц	Input current at maximum input voltage	$V_{CC} = MAX$,	V _I = 5.5 V			1			1	mA
lіН	High-level input current	$V_{CC} = MAX$,	V _I = 2.4 V			40			40	μΑ
Ι _Ι L	Low-level input current	$V_{CC} = MAX$,	$V_{I} = 0.4 \ V$		-1	-1.6		-1	-1.6	mA
ІССН	Supply current, outputs high	$V_{CC} = MAX$,	V _I = 5 V		7	11		7	11	mA
ICCL	Supply current, outputs low	$V_{CC} = MAX$,	V _I = 0		52	65		52	65	mA

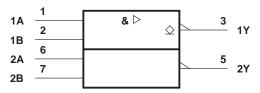
[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. § All typical values are at V_{CC} = 5 V, T_A = 25°C.

	PARAMETER			TEST CONDITIONS			MAX	UNIT
tPLH	Propagation delay time, low-to-high-level	output				18	25	
tPHL	Propagation delay time, high-to-low-level	output	I _O ≈ 200 mA,			18	25	
tTLH			$R_L = 50 \Omega$,	See Figure 1		5	8	ns
^t THL						7	12	
\/a	High lovel output voltage offer switching	SN55451B	V _S = 20 V,	I _O ≈ 300 mA,		V _S -6.5		m\/
VOH	High-level output voltage after switching	SN75451B	See Figure 2	-	V _S -6.5			mV



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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC publication 617-12.

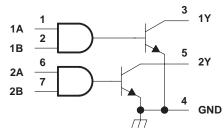
Pin numbers shown are for the D, JG, and P packages.

FUNCTION TABLE (each driver)

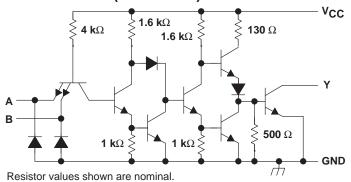
Α	В	Y
L	L	H (off state)
L	Н	H (off state)
Н	L	H (off state)
Н	Н	L (on state)

positive logic: $Y = \overline{AB} \text{ or } \overline{A} + \overline{B}$

logic diagram (positive logic)



schematic (each driver)



electrical characteristics over recommended operating free-air temperature range

	PARAMETER	TEST COL	IDITIONST	S	N55452E	3	SN75452B			UNIT
	PARAMETER	IESI CON	TEST CONDITIONS‡		TYP§	MAX	MIN	TYP§	MAX	UNII
VIK	Input clamp voltage	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$		-1.2	-1.5		-1.2	-1.5	V
Vol	Low-level output voltage	$V_{CC} = MIN,$ $I_{OL} = 100 \text{ mA}$	$V_{IH} = MIN,$		0.25	0.5		0.25	0.4	V
VOL		$V_{CC} = MIN,$ $I_{OL} = 300 \text{ mA}$	V _{IH} = MIN,		0.5	0.8		0.5	0.7	V
ЮН	High-level output current	V _{CC} = MIN, V _{OH} = 30 V	V _{IL} = 0.8 V,			300			100	μА
Ц	Input current at maximum input voltage	$V_{CC} = MAX$,	V _I = 5.5 V			1			1	mA
ΙΗ	High-level input current	$V_{CC} = MAX$,	V _I = 2.4 V			40			40	μΑ
IIL	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V		-1.1	-1.6		-1.1	-1.6	mA
ICCH	Supply current, outputs high	$V_{CC} = MAX$,	V _I = 0		11	14		11	14	mA
ICCL	Supply current, outputs low	$V_{CC} = MAX$,	V _I = 5 V		56	71		56	71	mA

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

	PARAMETER			TEST CONDITIONS			MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output					26	35	
tPHL	Propagation delay time, high-to-low-level output		I _O ≈ 200 mA,			24	35	no
tTLH	Transition time, low-to-high-level output	ransition time, low-to-high-level output		See Figure 1		5	8	ns
^t THL	Transition time, high-to-low-level output					7	12	
V	V		Vs = 20 V,	I _O ≈ 300 mA,		V _S −6.5		mV
VOH	High-level output voltage after switching	SN75452B	See Figure 2	_	V _S −6.5			IIIV



[§] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

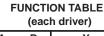
logic symbol†

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC publication 617-12.

Pin numbers shown are for the D, JG, and P packages.

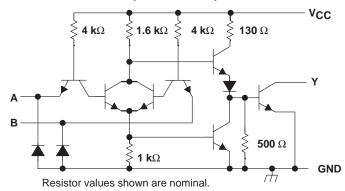
schematic (each driver)

logic diagram (positive logic)



Α	В	Y						
L	L	L (on state)						
L	Н	H (off state)						
Н	L	H (off state)						
Н	Н	H (off state)						

positive logic: $\underline{\underline{}}$ Y = A+B or $\overline{\overline{A}}$ $\overline{\overline{B}}$



electrical characteristics over recommended operating free-air temperature range

	DADAMETED	TEST SON	DITIONOT	8	N55453E	3	SN75453B			UNIT
	PARAMETER	TEST CONDITIONS‡		MIN	TYP§	MAX	MIN	TYP§	MAX	UNII
VIK	Input clamp voltage	V _{CC} = MIN,	$I_{I} = -12 \text{ mA}$		-1.2	-1.5		-1.2	-1.5	V
\/a.	Low-level output voltage	$V_{CC} = MIN,$ $I_{OL} = 100 \text{ mA}$	V _{IL} = 0.8 V,		0.25	0.5		0.25	0.4	٧
VOL		V _{CC} = MIN, I _{OL} = 300 mA	$V_{IL} = 0.8 V,$		0.5	0.8		0.5	0.7	V
ЮН	High-level output current	V _{CC} = MIN, V _{OH} = 30 V	V _{IH} = MIN,			300			100	μΑ
II	Input current at maximum input voltage	$V_{CC} = MAX$,	V _I = 5.5 V			1			1	mA
lін	High-level input current	$V_{CC} = MAX$,	V _I = 2.4 V			40			40	μΑ
I _{IL}	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V		-1	-1.6		-1	-1.6	mA
ICCH	Supply current, outputs high	$V_{CC} = MAX$,	V _I = 5 V		8	11		8	11	mA
ICCL	Supply current, outputs low	V _{CC} = MAX,	V _I = 0		54	68		54	68	mA

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

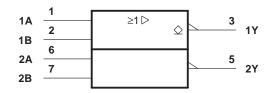
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
^t PLH	PLH Propagation delay time, low-to-high-level output					18	25	
^t PHL	PHL Propagation delay time, high-to-low-level output		I _O ≈ 200 mA,	$C_L = 15 pF$,		18	25	no
tTLH			$R_L = 50 \Omega$,	See Figure 1		5	8	ns
tTHL	t _{THL} Transition time, high-to-low-level output					7	12	
Vон	High-level output voltage after switching	SN55453B	V _S = 20 V, See Figure 2	I _O ≈ 300 mA,		V _S -6.5		mV
	riigii-ievei output voitage after switching	SN75453B			V _S -6.5			



[§] All typical values are at V_{CC} = 5 V, T_A = 25°C.

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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC publication 617-12.

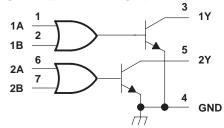
Pin numbers shown are for the D, JG, and P packages.

FUNCTION TABLE (each driver)

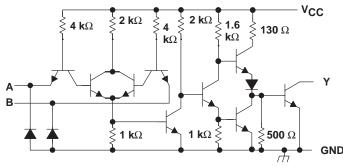
Α	В	Y
L	L	H (off state)
L	Н	L (on state)
Н	L	L (on state)
Н	Н	L (on state)

positive logic: $Y = \overline{A+B}$ or \overline{AB}

logic diagram (positive logic)



schematic (each driver)



Resistor values shown are nominal.

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS‡		SN55454B			SN75454B			UNIT
				MIN	TYP§	MAX	MIN	TYP§	MAX	UNIT
VIK	Input clamp voltage	$V_{CC} = MIN,$	$I_{ } = -12 \text{ mA}$		-1.2	-1.5		-1.2	-1.5	V
\/a:	Low lovel output voltage	V _{CC} = MIN, V _{IH} = MIN, I _{OL} = 100 mA	0.25	0.5		0.25	0.4	V		
VOL	Low-level output voltage	$V_{CC} = MIN,$ $I_{OL} = 300 \text{ mA}$	V _{IH} = MIN,		0.5	0.8		0.5	0.7	v
ЮН	High-level output current	V _{CC} = MIN, V _{OH} = 30 V	V _{IL} = 0.8 V,			300			100	μΑ
lį	Input current at maximum input voltage	$V_{CC} = MAX$,	V _I = 5.5 V			1			1	mA
lн	High-level input current	$V_{CC} = MAX$,	V _I = 2.4 V			40			40	μΑ
IIL	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V		-1	-1.6		-1	-1.6	mA
ICCH	Supply current, outputs high	$V_{CC} = MAX$,	V _I = 0		13	17		13	17	mA
ICCL	Supply current, outputs low	$V_{CC} = MAX$,	V _I = 5 V		61	79		61	79	mA

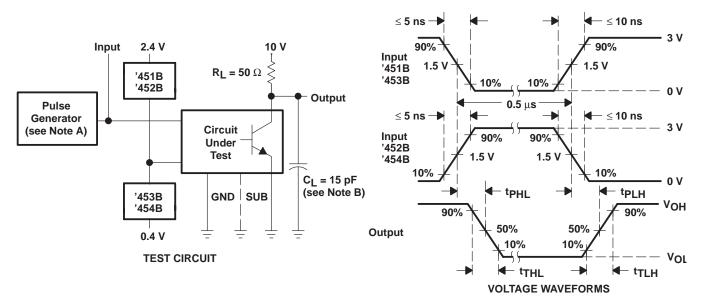
[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER			TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output					27	35	
tPHL	Propagation delay time, high-to-low-level output		I _O ≈ 200 mA,	C _L = 15 pF, See Figure 1		24	35	ns
tTLH	Transition time, low-to-high-level output		$R_L = 50 \Omega$,			5	8	
tTHL	Transition time, high-to-low-level output					7	12	
VOH	ligh lovel output voltage ofter ovitebing	SN55454B	V _S = 20 V, See Figure 2	I _O ≈ 300 mA,		V _S -6.5		mV
	High-level output voltage after switching	SN75454B			V _S -6.5			IIIV



[§] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

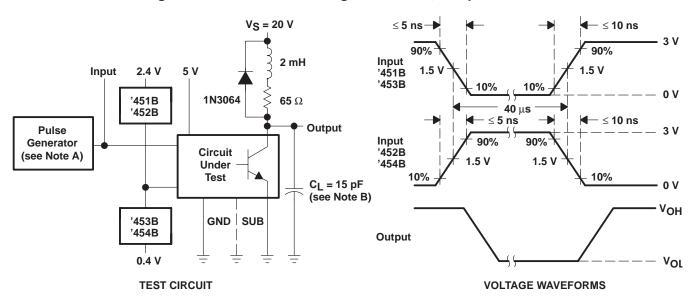
PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω .

B. C_L includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms, Complete Drivers



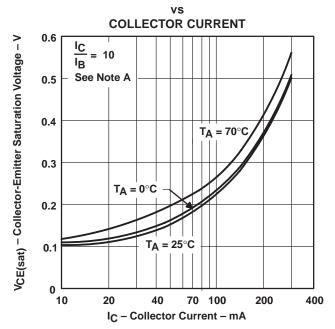
NOTES: A. The pulse generator has the following characteristics: PRR \leq 12.5 kHz, Z_{O} = 50 Ω .

B. C_L includes probe and jig capacitance.

Figure 2. Test Circuit and Voltage Waveforms for Latch-Up Test of Complete Drivers

TYPICAL CHARACTERISTICS

TRANSISTOR COLLECTOR-EMITTER SATURATION VOLTAGE



NOTE A: These parameters must be measured using pulse techniques, $t_{\text{W}}=300~\mu\text{s},$ duty cycle $\leq 2\%.$

Figure 3



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